

Enabling research: Silicon optics steady state magnetic field sensor

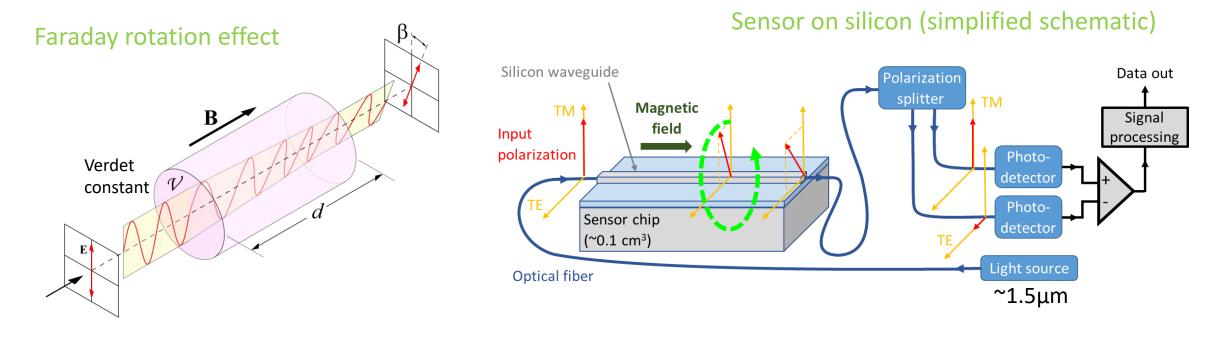
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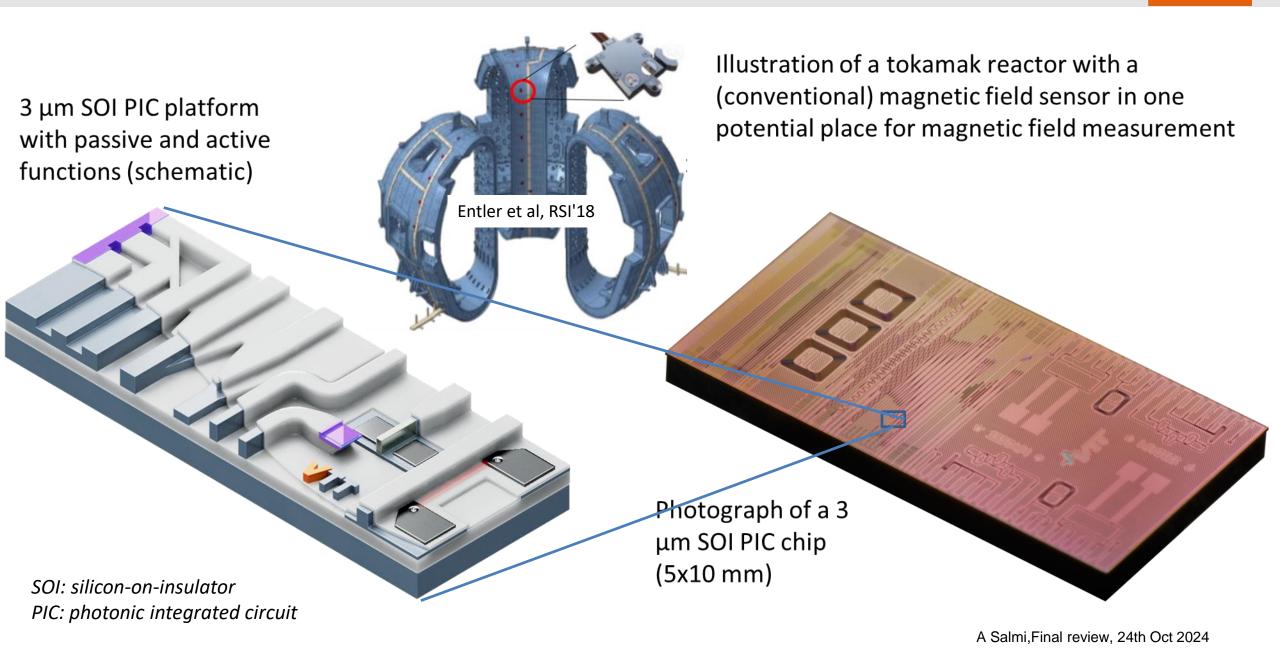
Measurement concept



- Aim: develop a prototype steady state magnetic field sensor
- **Physics principle**: Faraday rotation of light under magnetic field influencing the output of an integrated polarization splitter
- Technology: Photonic integrated circuit (PIC) based on 3 µm thick silicon-on-insulator (SOI) waveguides
- **Speciality**: Folded waveguides and mirror-based U-bends to accumulate Faraday rotation, novel mirror-based polarization splitters, and a method to avoid the impact of unwanted Faraday rotation in input/output fibers

Big picture

VTT



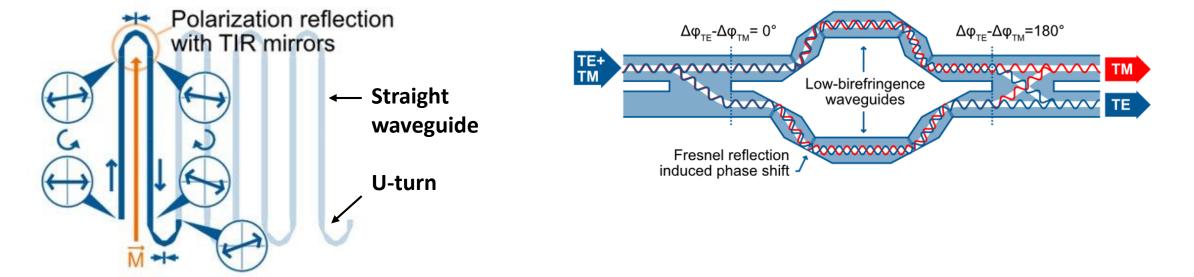
Multiple components needed for a sensor

Faraday rotator based on

- Straight waveguides with dimensions and coating optimized for zero birefringence
- Folded waveguides with U-turns based on total internal reflection (TIR) mirrors

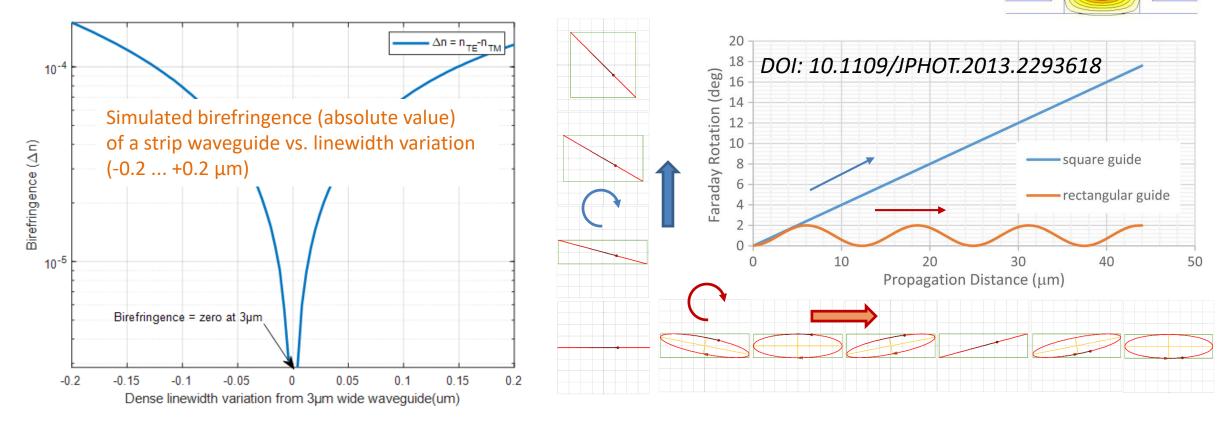
Polarisation splitter at the input and output of the Faraday rotator

- To create linear input polarization
- To measure the amount of Faraday rotation

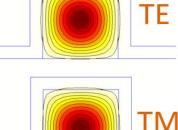


~Zero birefringence waveguides

- Zero birefringence of waveguides is needed for efficient Faraday rotation (as in the blue line)
- Stress free 3 µm wide strip waveguide can produce zero birefringence, but needs good linewidth control

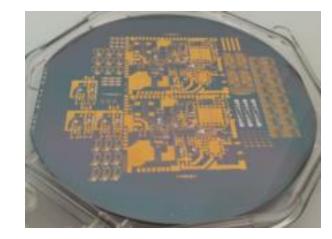






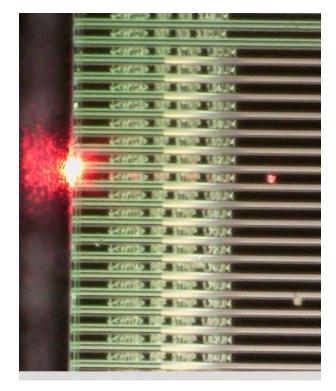
Manufacturing workflow

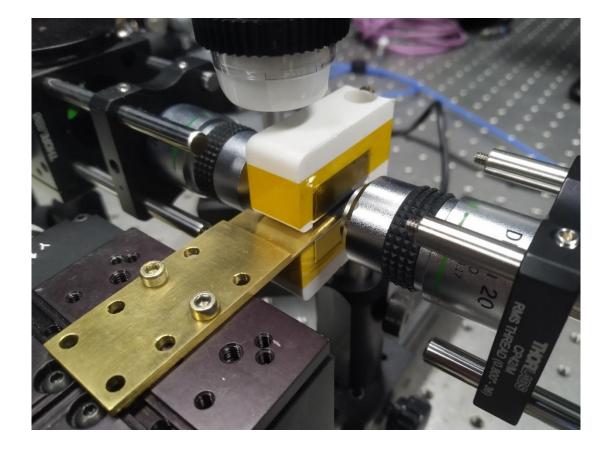
- Wafer processing involves ~30 separate steps from design, to masking, etching, polishing, cutting
 - Either expensive or slow
- Cost saving means Multi-Wafer-Process with wafer shared and processed with multiple projects on one go
- Multiple specialists needed
- This was initially thought to be the limiting factor
- However, even more problems rose from difficulties in finding the Faraday effect



Faraday rotation measurement setup

- Movable permanent magnet with 1 T allows clean measurement of with and without magnetic field
 - COMSOL calculations confirm magnetic field uniformity





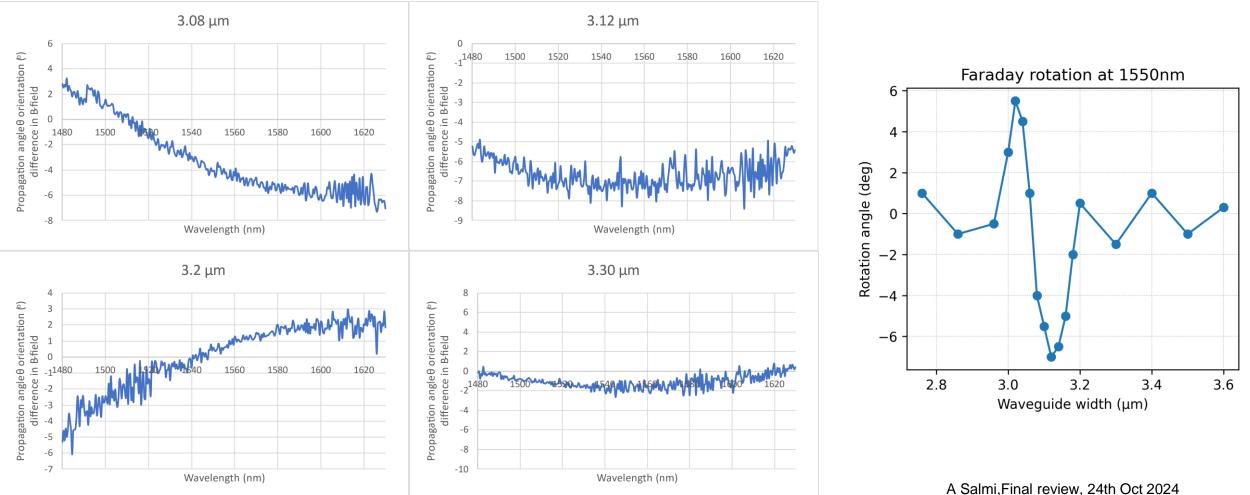
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Rotation angle difference measurement @1T

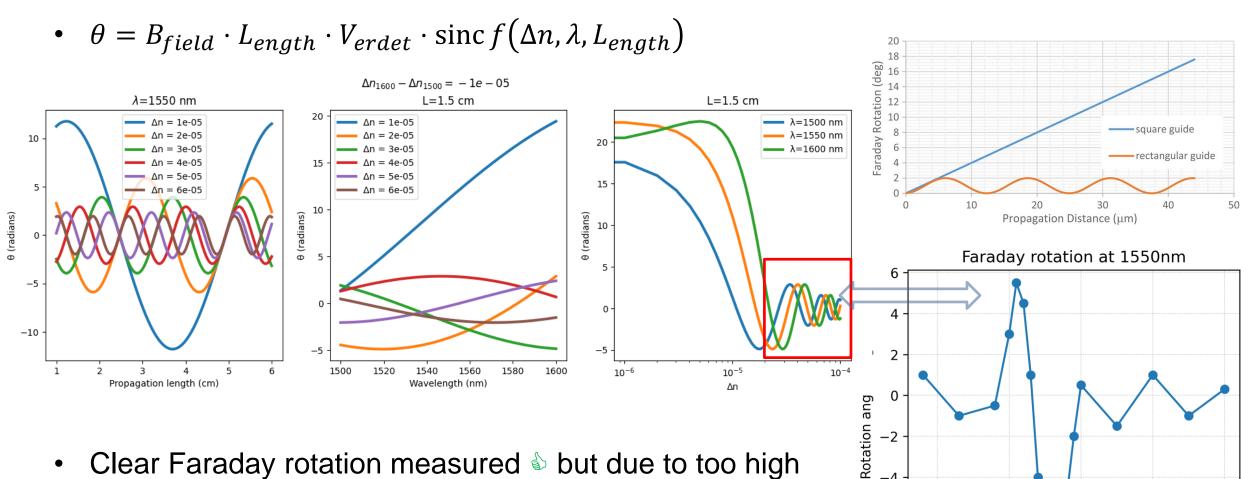
 Rotation angle should be ~22.5deg for Verdet constant 15 [deg/T/cm] at zero birefringence

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• Is this Faraday rotation?



Faraday rotation



- Clear Faraday rotation measured but due to too high birefringence rotation does not accumulate but oscillates
- High sensitivity not feasible by increasing waveguide length

A Salmi, Final review, 24th Oct 2024

Waveguide width (µm)

3.2

3.4

3.6

-6

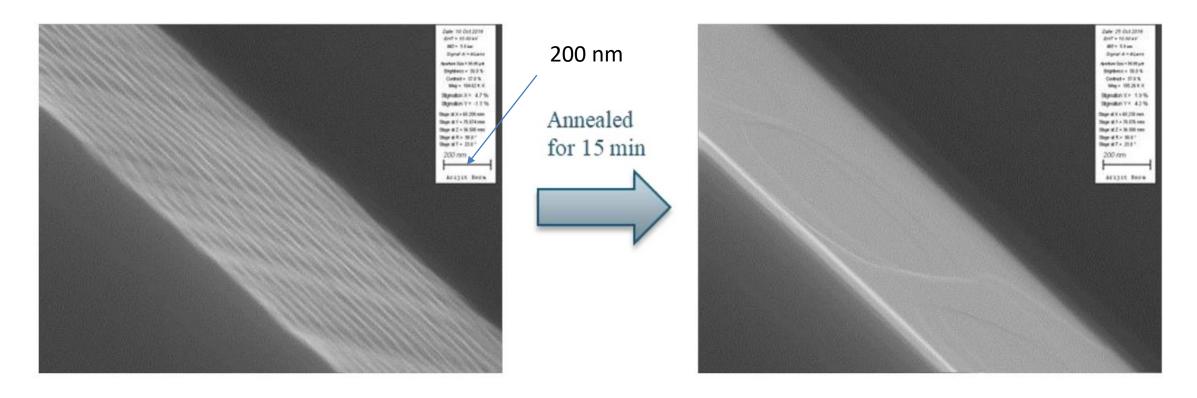
2.8

3.0

Hydrogen annealing for smoother waveguides

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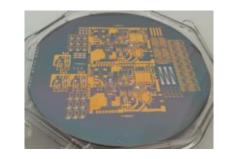
- SEM images of Hydrogen annealed waveguide surface after 15 min treatment
- Measurements show 75% improvement in polarisation extinction ratio and attenuation down to 4 dB/m

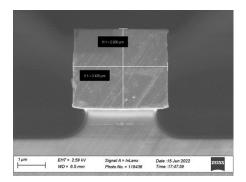


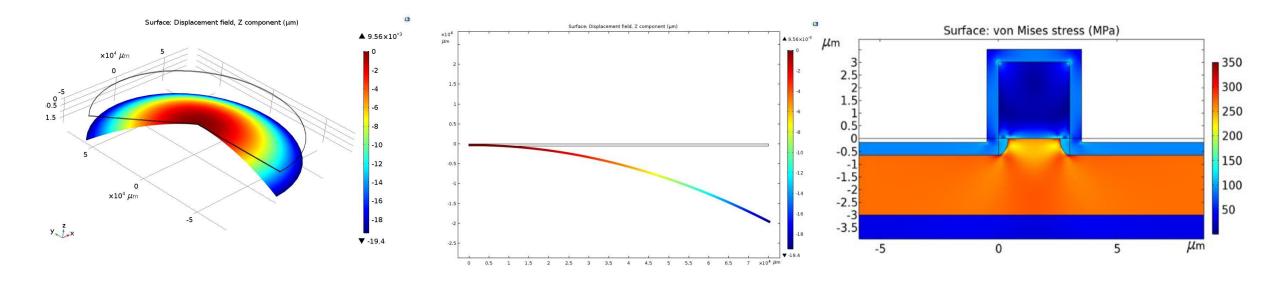
Experimentally inferred oxide stress values

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- Oxides on silicon monitor wafers
 - Bow measurements before and after oxide deposition
 - COMSOL modelling to define corresponding wafer bending value
 - \Rightarrow Experimentally defined stress value



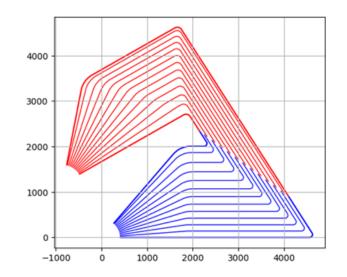




3D axisymmetric model

Birefringence measurements

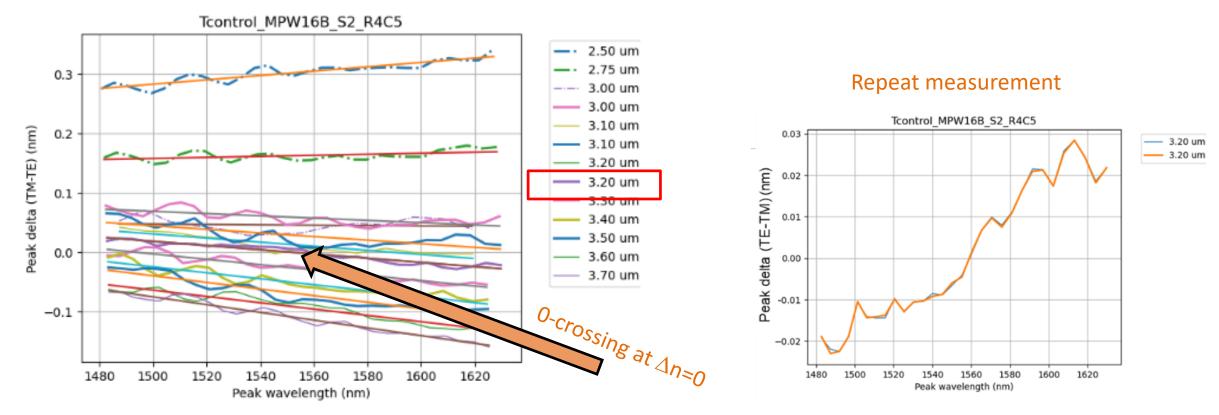
- Effective index birefringence cannot be measured from a single waveguide
 - Specific test structures are needed for each waveguide dimension of interest
- Two approaches utilised
 - Arrayed waveguide gratings (AWG)
 - Folded waveguides with a 3-point scan in straight section lengths





AWG measurements

- Rough scan of waveguide widths point to 3.2µm
- Measurement noise is small as seen from repeat measurement
 - Small scale variation likely due to 3D roughness of the waveguide surfaces

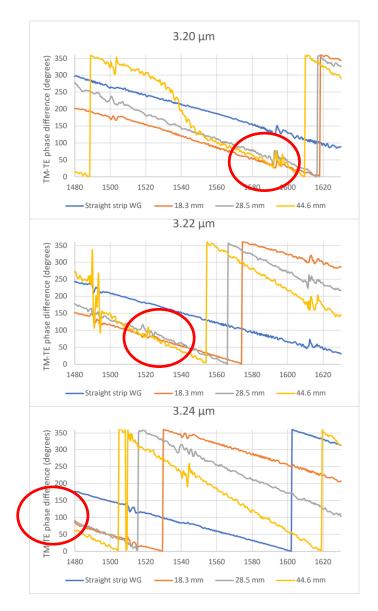


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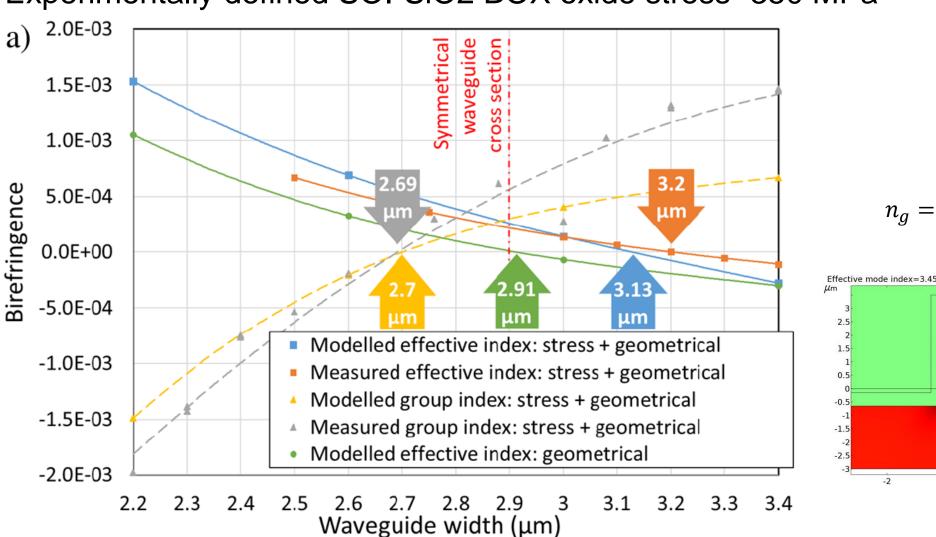
Folded waveguide

- Test structures from the same wafer show the same width for the minimum birefringence ~3.2µm
- The location of the 3-way crossing point moves to smaller wavelength with increasing width similar to AWG measurements
- NB: waveguides from another processing run have the crossing near ~3.1µm indicating sensitivity to the exact manufacturing 'recipe'

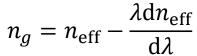


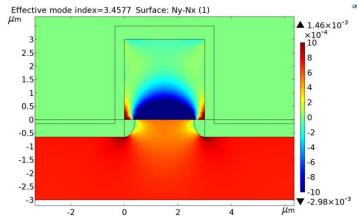
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Simulated birefringence



• Experimentally defined SOI-SiO2 BOX oxide stress -350 MPa





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- Comprehensive experimental and numerical research conducted to gain insights in birefringence properties of 1.5µm IR light in 3µm waveguides
- Good agreement found between multiple measurement techniques and modelling confirming the sensitivity on both the geometry and the wavelength
 - Explains why Faraday rotation is less than initially hoped for a sensor application

Zero Birefringence and Zero Birefringence Dispersion in 3 µm-thick Silicon-on-Insulator Waveguides

Katherine Bryant¹, Ari Hokkanen¹, Dura Shahwar^{1,2}, Mikko Harjanne¹, Antti Salmi¹, and Timo Aalto¹

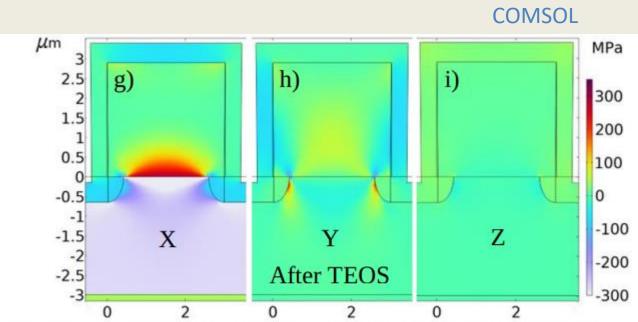
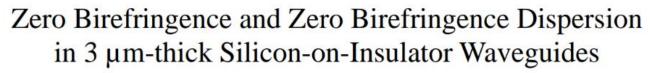


Fig. 18. a-c) Stress tensor components after SOI waveguide etching, d-f) stress tensor components after SOI wafer heating to 670°C for TEOS deposition and g-i) stress tensor components after TEOS deposition. The x direction is horizontal, y is vertical, and z is along the waveguide.

Conclusions

- COMSOL modelling in fair agreement with measurements
- Faraday effect demonstrated but found to be in the non-ideal 'oscillating' regime
- The inherently high birefringence of the 3µm silicon waveguide makes it difficult to obtain highly sensitive magnetic field sensor as targeted
- TIR mirror based $n\cdot\pi$ phase difference U-bends manufactured exhibited larger loss of light poorer polarization control than needed likely due to wall roughness
- Not recommended for further development until manufacturing tolerances are improved and birefringence / dispersion are made significantly smaller



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